

SAMPLE APPROVAL SHEET

DESCRIPTIONS:

•3.5x2.8x1.9mm SMD LED

•Emitting Color:Orange

•Lens Color:Water Clear

CUSTOMER:

ITEM P/N:

L3528SEAC

CUSTOMER P/N:

CUSTOMER APPROVED SIGNATURES

CHECKED BY



PRELIMINARY SPEC

3.5x2.8mm SMD CHIP LED

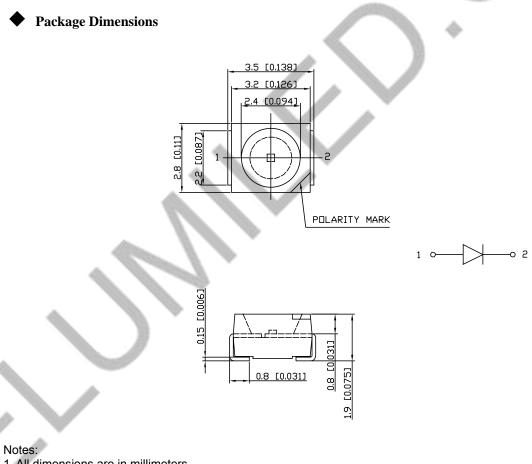
PART NO: L3528SEAC ORANGE

Features

- 3.5mmx2.8mm SMT LED, 1.9mm THICKNESS.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- PACKAGE : 2000PCS / REEL.
- RoHS COMPLIANT.

Applications

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and b lighting in telephone and fax.
 Flat backlight for LCD switch and symbol. back-



- 1. All dimensions are in millimeters.
- 2. Tolerance is ± 0.25 unless otherwise noted.
- 3. Specifications are subject to change without notice.



Device Selection Guide

Part No.	Cł	Lens color	
L3528SEAC	Material	Emitted color	Water clear
LUUZOSLAC	(InGaAIP)	ORANGE	Water clear

Absolute Maximum Ratings at TA=25°C

Parameter	Symbol	Value	Unit	
Power Dissipation	Pd	62	mW	
Forward Current	lF	25	mA	
Peak Forward Current*1	 FP	100	mA	
Reverse Voltage	VR	5	v	
Operating Temperature	Topr	-40°C To +85°C		
Storage Temperature	Tstg	-40°C To +85°C		

Notes:

*1: Pulse width≤0.1ms, Duty cycle≤1/10

Parameter	Symbol	Min.	Тур.	Max	Unit	Test Conditions
Forward Voltage	VF	1.8		2.6	V	IF=20mA
Reverse Current	lr	_	—	10	μA	VR=5V
Dominate Wavelength	λD	601	—	613	nm	IF=20mA
Luminous Intensity	lv	170		385	mcd	IF=20mA
Viewing Angle	2 0 1/2		120	_	Deg.	IF=20mA

Electrical / Optical Characteristics at TA=25°C

Remarks:

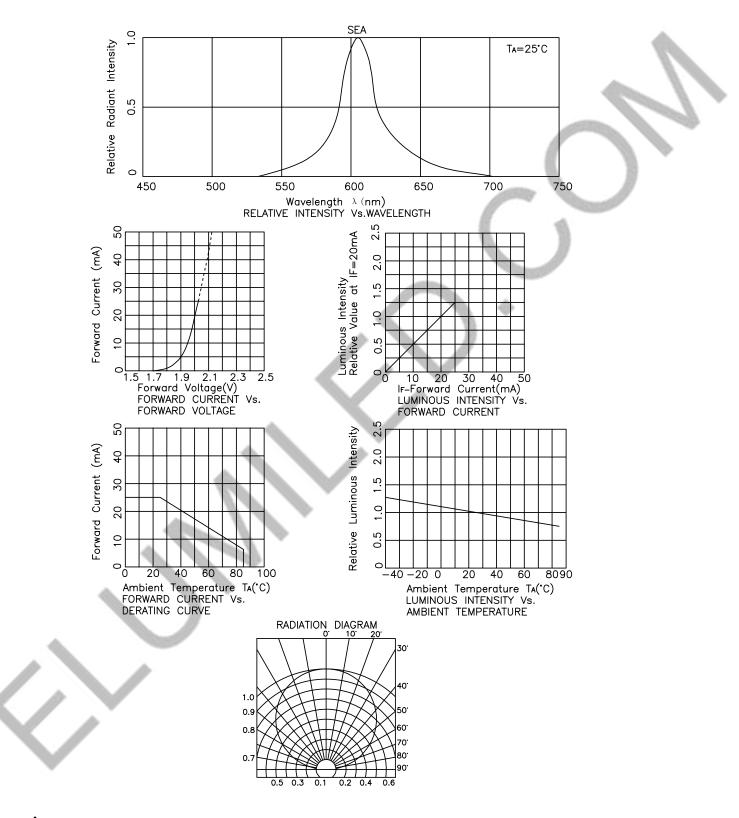
If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or chromaticity), the typical accuracy of the sorting process is as follows:

1. wavelength: ±1nm

2. Luminous Intensity: ±15%

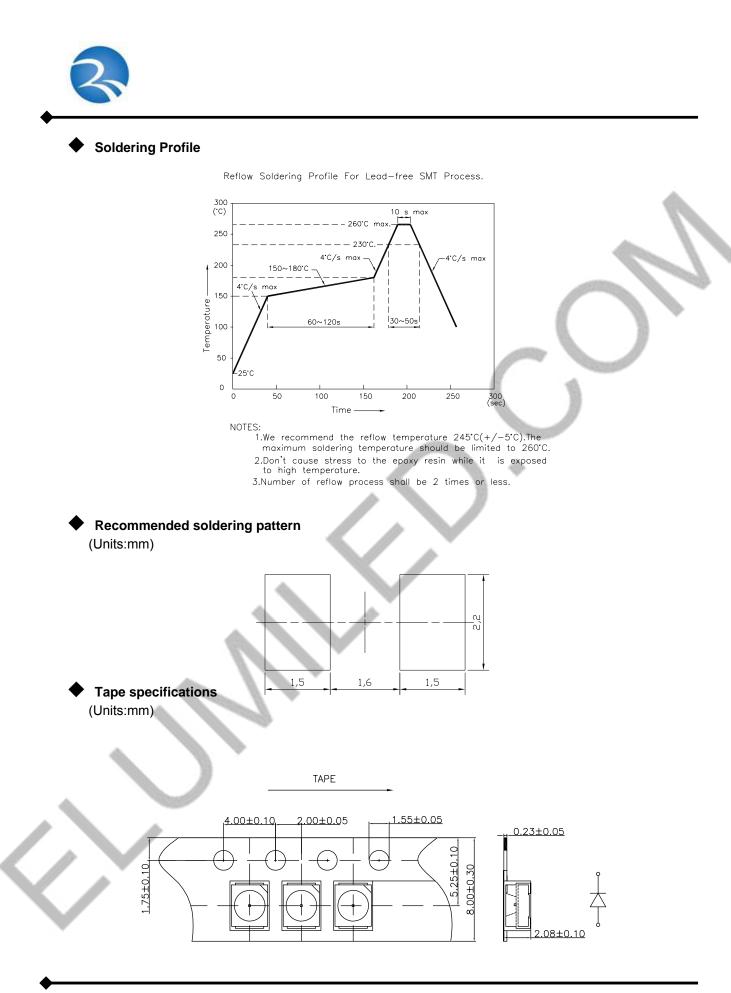
3. Forward Voltage: ±0.1V





Typical Electrical/Optical Characteristics Curves

L3528SEAC



L3528SEAC



VF Rank

Rank	VF(V)		Condition	
	Min	Мах		0
В	1.8	2.0		
С	2.0	2.2	IF=20mA	
D	2.2	2.4		¢
E	2.4	2.6		

 $\textbf{Tolerance:} \pm 0.1 V$

• λD Rank

			A
λD(nm)		Condition	
Rank	Min	Max	Condition
1	601	605	
2	605	609	IF=20mA
3	609	613	

Tolerance:±1nm

IV Rank

	IV(n		
Rank	Min	Max	Condition
Q	170	225	
R	225	295	IF=20mA
S	295	385	

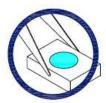
Tolerance:±15%



Handling Precautions

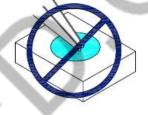
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.



2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

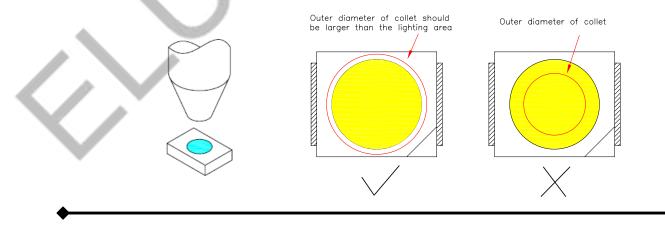




3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratch the silicone lens or damage the internal circuitry.



During surface-mounting, the pickup capillary diameter should be larger than the silicone lens to insure the capillary does not scratch or damage the lens.

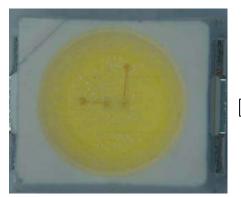


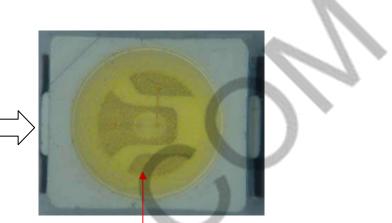
L3528SEAC



Cautions

- —. This product is not anti-sulfide
- 1. The sulfide bad picture





Normal material

Sulfide materials, stent Bowl Cup silver layer black

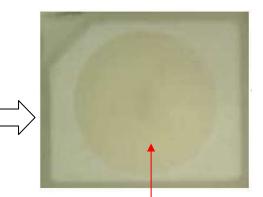
- 2.Anti-sulfide method LED
- a. Selection of anti-vulcanization of LED product LED

b. Control the concentration of sulfide ions in the external environment, such as the content of the raw materials of sulfide sulfur ions in the air content

- \square . This product is not anti-acidification
- 1. The acidification bad picture:



Normal material



The acidification materials, bleached phosphor

2. Anti-acidification method LED

Using the process, put an end to use with acidic glass glue, such as coated LED colloid or fixed LED application products



• CAUTIONS:

1.Storage

- In order to avoid the absorption of moisture, it is recommended to store in the dry box (or desicca tor) with a desiccant. Otherwise, to store them in the following environment is recommended. Temperature: 5°C~30°C
 Humidity: 60% HR max.
- Attention after opened

However LED is corresponded SMD, when LED be soldered dip, interfacial separation may affect The light transmission efficiency, causing the light intensity to drop. Attention in followed.

- a. After opened and mounted, the soldering shall be quickly.
- b. Keeping of a fraction

Temperature: 5°C~40°C

Humidity: less than 30%

- In case or more than 1 week passed after opening or change color of indicator on desiccant components shall be dried 10-12hr. at $60^{\circ}C \pm 3^{\circ}C$.
- In case of supposed the components is humid, shall not be dried dip-solder just before. 100Hr at 80°C±3°C or 12Hr at 100°C±3°C

2.ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

- The following procedures may decrease the possibility of ESD damage.
- All production machinery and test instruments must be electrically grounded.
- Use a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- Maintain a humidity level of 50% or higher in production areas.
- Use anti-static packaging for transport and storage.